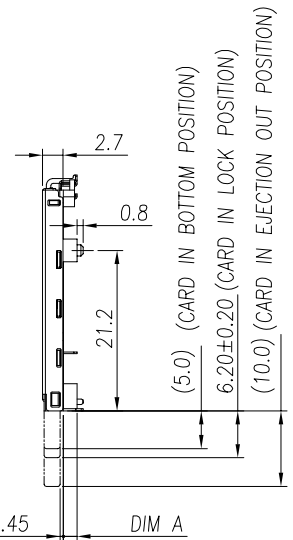
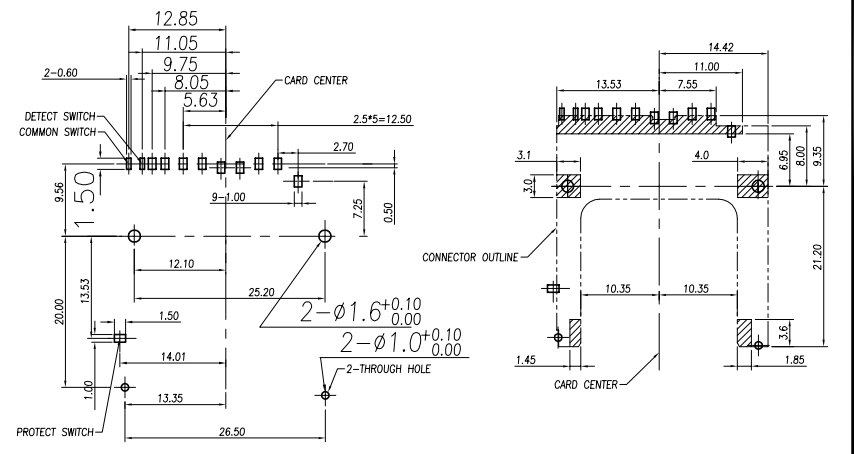
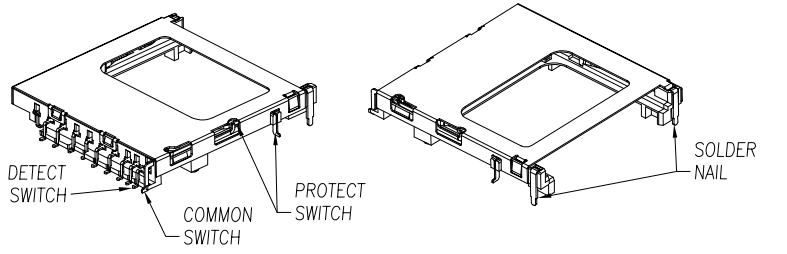


OFFSET	DIM.A
00	
01	1.80
02	2.00



NOTE:
250041FB012 □□00Z □
2

- Selective plating
 S1-05u"Min.Gold in contact area/
 100u"Min.Tin in solder area.
 S2-Gold flash in contact area/
 100u"Min.Tin in solder area.
 S3-10u"Min.Gold in contact area/
 100u"Min.Tin in solder area.
 S4-15u"Min.Gold in contact area/
 100u"Min.Tin in solder area.
 S5-30u"Min.Gold in contact area/
 100u"Min.Tin in solder area.
 S6-50u"Min.Gold in contact area/
 100u"Min.Tin in solder area.
- Package :
L-Reel package



NO.	DESCRIPTION	MATERIAL	COLOR	REMARK
11	SPRING	SUS		
10	FITTING NAIL	C2680-H		Gold/Tin plated
9	HOOK	SUS		
8	LOCK PIN	SUS		
7	SLIDER	PPA	BLACK	UL94V-0
6	TERMINAL	C5191-H		Gold/Tin plated
5	PROTECT PIN	C5191-EH		Gold/Tin plated
4	DETECT PIN	C5191-H		Gold/Tin plated
3	COMMON PIN	C5191-EH		Gold/Tin plated
2	PLASTIC	LCP	BLACK	UL94V-0
1	SHELL	SUS		

實盈		SUYIN CONNECTOR	
名稱 TITLE: 2.50mm Pitch SD Card			
料號	PART NO.	250041FB012SX00ZX	
料號	PART NO. (OLD)		
圖號	D	250041FB012SX00ZX	
DRAWING NO.	取模碼		
SCALE	5:1	UNIT	mm
			A4

工程變更通知單號 ECN(DCN) NO.	版次 REV	日期 DATE	說明 DESCRIPTION	改變 CHANGE	承認 APPRO.	Angle	±1°	DRAW	繪圖員
	0		NEW			30 ~	±0.30	DESIGN	設計
						10 ~ 30	±0.20	CHECK	校閱
						~ 10	±0.10	APPRO.	承認

GENERAL TOLERANCE
UNLESS OTHERWISE NOTED